

UNISONIC TECHNOLOGIES CO., LTD

MCK100

Preliminary

SCR

SENSITIVE GATE SILICON CONTROLLED RECTIFIERS REVERSE BLOCKING THYRISTORS

DESCRIPTION

The UTC **MCK100** is a sensitive gate silicon controlled rectifiers reverse blocking thyristor. It provides the customers with high surge current capability, high blocking voltage to 600 V and high switching speed.

The UTC **MCK100** is suitable for sensing and detection circuits and high volume line – powered consumers applications

FEATURES

- * High Surge Current Capability
- * High Blocking Voltage to 600 V
- * On–State Current Rating of 0.8 A RMS @ T_C=80°C
- * High Switching Speed (20 V/ μ s Minimum @ T_c=110°C)
- * Reliability and Uniformity

SYMBOL

3.Anode O-----

2.Gate

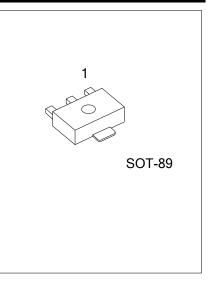
→ O 1.Cathode

ORDERING INFORMATION

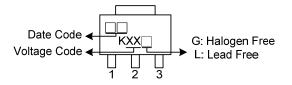
Ordering Number		Deekage	Pin a	assigni	Deeking	
Lead Free	Halogen Free	Package	1	2	3	Packing
MCK100L-x-xx-AB3-R	MCK100G-x-xx-AB3-R	SOT-89	К	G	Α	Tape Reel
Note: Pin assignment: G: Gat	e K: Cathode A: Anode					

(1)Packing Type (2)Package Type (3)Rank (4)Peak Voltage (5)Lead Free	 (1) R: Tape Reel (2) AB3: SOT-89 (3) xx: refer to Classification of I_{GT} (4) 3: 100V, 4: 200V, 6: 400V, 8: 600V (5) G: Halogen Free L : Lead Free
(5)Lead Free	(5) G: Halogen Free L: Lead Free
	(2)Package Type (3)Rank (4)Peak Voltage

MARKING



MCK100



■ ABSOLUTE MAXIMUM RATINGS (TJ=25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT	
	MCK100-3		100	
Peak Repetitive Off-State Voltage(Note 2) (T, =-40 ~ 110°C, Sine Wave, 50 ~ 60Hz,	MCK100-4	V _{DRM}	200	V
(1j=-40 ~ 110 C, Sille Wave, 50 ~ 60Hz, Gate Open)	MCK100-6	V _{RRM}	400	v
	MCK100-8		600	
Peak Gate Voltage – Reverse(T _A =25°C, Puls	V _{GRM}	5.0	V	
On-Sate RMS Current (T _C =80°C) 180°C Con	I _{T(RMS)}	0.8		
Peak Non-Repetitive Surge Current	I _{TSM}	10	А	
(1/2 cycle, Sine Wave, 60Hz, T _J =25°C)	ISM	10	~	
Peak Gate Current-Forward (T _A =25°C, Pulse	I _{GM}	1.0	А	
Circuit Fusing Considerations (t=8.3 ms)	l ² t	0.415	A ² s	
Forward Peak Gate Power (T _A =25°C, Pulse \	P _{GM}	2	W	
Forward Average Gate Power (T _A =25°C, t=8.	P _{G(AV)}	0.1	W	
Operating Junction Temperature @ Rated V _F	TJ	-40 ~ 125	°C	
Storage Temperature	T _{STG}	-40 ~ 150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ _{JA}	200	°C/W
Junction to Case	θ」	75	°C/W

ELECTRICAL CHARACTERISTICS(TJ=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Peak Repetitive Forward or T _C =25°C		I _{DRM}	V_D =Rated V_{DRM} and V_{RRM} ,			10	
Reverse Blocking Current (Note 1)	Reverse Blocking Current (Note 1) T _c =110°C		R _{GK} =1kΩ			100	μA
ON CHARACTERISTICS							
Peak Forward On-State Voltage (N	Note 3)	V _{TM}	I _{TM} =1A Peak @ T _A =25°C			1.7	V
Gate Trigger Current (Continuous	dc) (Note2)	I _{GT}	V _{AK} =7.0V, R _L =100Ω, T _C =25°C		40	200	μA
Lielding Current (Note 2)	T _C =25°C	- I _H	V _{AK} =7V, initiating		0.5	5.0	
Holding Current (Note 3)	T _C =-40°C		current=20mA			10	mA
Latab Command	T _C =25°C	- IL	V _{AK} =7V, I _G =200μA		0.6	10	
Latch Current	T _C =-40°C					15	mA
Gate Trigger Current	T _C =25°C	V	V_{GT} V_{AK} =7V, R _L =100 Ω -		0.62	0.8	V
(continuous dc) (Note 2)	T _C =-40°C	VGT				1.2	v
DYNAMIC CHARACTERISTICS							
		V _D =Rated V _{DRM} , Exponential					
Critical Rate of Rise of Off-State Voltage		dV/dt	Waveform, R _{GK} =1000Ω,	20	35		V/µs
			T _J =110°C				
Critical Data of Diag of On State Compart		d:/dt	I _{PK} =20A, P _W =10μs,			50	A /a
Critical Rate of Rise of On-State Current		di/dt	diG/dt=1A/µs, Igt=20mA			50	A/µs

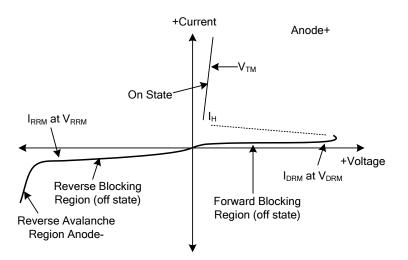
Notes: 1. R_{GK} =1000 Ω included in measurement.

- 2. Does not include R_{GK} in measurement.
- 3. Indicates Pulse Test Width ${\leq}1.0ms,$ duty cycle ${\leq}1\%$



■ VOLTAGE CURRENT CHARACTERISTIC OF SCR

SYMBOL	PARAMETER
V _{DRM}	Peak Repetitive Off Stat Forward Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Off State Reverse Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Peak On State Voltage
I _H	Holding Current



CLASSIFICATION OF I_{GT}

RANK	В	С	AA	AB	AC	AD
RANGE	48 ~ 105	95 ~ 200	8 ~ 16	14 ~ 21	19 ~ 25	23 ~ 52

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